

TLC27xx Precision Dual Operational Amplifiers

1 Features

- Wide range of supply voltages over specified temperature range:
 - 0°C to 70°C: 3V to 16V
 - –40°C to 125°C: 4V to 16V
 - –55°C to 125°C: 4V to 16V
- Single-supply operation
- Common-mode input voltage range extends below the negative rail (C-suffix, I-suffix types)
- Low noise: typically 10.8nV/√Hz at f = 1kHz
- Output voltage range includes negative rail
- High input impedance: >10¹² Ω typical
- ESD-protection circuitry
- Small-outline package option also available in tape and reel
- Designed-in latch-up immunity

2 Description

The TLC272 and TLC277 precision dual operational amplifiers combine a wide range of input offset voltage grades with low offset voltage drift, high input impedance, low noise, and speeds approaching those of general-purpose BiFET devices.

The extremely high input impedance, low bias currents, and boosted slew rates make these cost effective devices an excellent choice for applications previously reserved for BiFET and NFET products. Four offset voltage grades are available (C-suffix and I-suffix types), ranging from the low-cost TLC272 (10mV) to the high-precision TLC277 (500μV). These advantages, in combination with good common-mode rejection and supply voltage rejection, make these devices a good choice for new state-of-the-art designs as well as for upgrading existing designs.

Device Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
TLC272	P (PDIP, 8)	9.81mm × 9.43mm
	D (SOIC, 8)	4.9mm × 6mm
	PS (SOP, 8)	6.2mm × 7.8mm
	PW (TSSOP, 8)	3mm × 6.4mm
TLC272A	P (PDIP, 8)	9.81mm × 9.43mm
	D (SOIC, 8)	4.9mm × 6mm
TLC272B	P (PDIP, 8)	9.81mm × 9.43mm
	D (SOIC, 8)	4.9mm × 6mm
	PS (SOP, 8)	6.2mm × 7.8mm
TLC277	P (PDIP, 8)	9.81mm × 9.43mm
	D (SOIC, 8)	4.9mm × 6mm
	PS (SOP, 8)	6.2mm × 7.8mm

(1) For more information, see [Section 9](#)

(2) The package size (length × width) is a nominal value and includes pins, where applicable.



Table of Contents

1 Features	1	5.2 Input Bias Current.....	14
2 Description	1	5.3 Low-Level Output Voltage.....	14
3 Pin Configuration and Functions	3	5.4 Input Offset Voltage Temperature Coefficient.....	14
4 Specifications	4	6 Application and Implementation	15
4.1 Absolute Maximum Ratings.....	4	6.1 Application Information.....	15
4.2 Recommended Operating Conditions.....	4	7 Device and Documentation Support	18
4.3 Electrical Characteristics.....	5	7.1 Receiving Notification of Documentation Updates....	18
4.4 Electrical Characteristics.....	6	7.2 Support Resources.....	18
4.5 Electrical Characteristics.....	7	7.3 Trademarks.....	18
4.6 Electrical Characteristics.....	8	7.4 Electrostatic Discharge Caution.....	18
4.7 Operating Characteristics.....	9	7.5 Glossary.....	18
4.8 Typical Characteristics.....	10	8 Revision History	18
5 Parameter Measurement Information	13	9 Mechanical, Packaging, and Orderable Information..	19
5.1 Single-Supply vs Split-Supply Test Circuits.....	13		

3 Pin Configuration and Functions

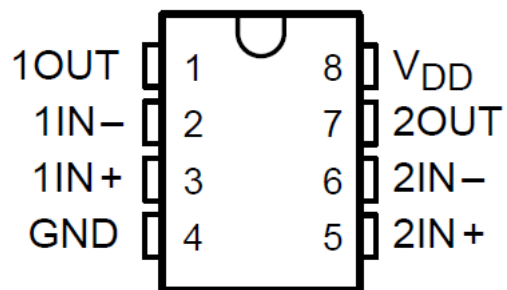


Figure 3-1. D, JG, P, or PW Package (Top View)

4 Specifications

4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

			MIN	MAX	UNIT
V_{DD}	Supply voltage ⁽²⁾			18	V
V_{ID}	Differential input voltage ⁽³⁾		$-V_{DD}$	$+V_{DD}$	
V_I	Input voltage range	Any input	-0.3	V_{DD}	V
I_I	Input current		-5	5	mA
I_O	Output current	Each output	-30	30	mA
	Total current into V_{DD}			45	mA
	Total current out of GND			45	mA
	Duration of short-circuit current at (or below) 25°C ⁽⁴⁾			Unlimited	
T_A	Operating free-air temperature	C suffix	0	70	°C
		I suffix	-40	85	
T_{stg}	Storage temperature		-65	150	°C
	Lead temperature 1,6mm (1/16 inch) from case for 10 seconds	D package		260	°C
		P package			
		PW package			
	Lead temperature 1,6mm (1/16 inch) from case for 60 seconds	JG package		300	°C

- (1) Stresses beyond those listed under [Section 4.1](#) can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under [Section 4.2](#) is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.
- (2) All voltage values, except differential voltages, are with respect to network ground.
- (3) Differential voltages are at $IN+$ with respect to $IN-$.
- (4) The output can be shorted to either supply. Temperature and/or supply voltages must be limited to make sure that the maximum dissipation rating is not exceeded (see application section).

4.2 Recommended Operating Conditions

			C SUFFIX		I SUFFIX		UNIT
			MIN	MAX	MIN	MAX	
V_{DD}	Supply voltage		3	16	4	16	V
V_{IC}	Common-mode input voltage	$V_{DD} = 5V$	-0.2	3.5	-0.2	3.5	V
		$V_{DD} = 10V$	-0.2	8.5	-0.2	8.5	
T_A	Operating free-air temperature		0	70	-40	85	°C

4.3 Electrical Characteristics

at specified free-air temperature, $V_{DD} = 5V$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS		T _A	TLC272C, TLC272AC, TLC272BC, TLC277C			UNIT
						MIN	TYP	MAX	
V _{IO}	Input offset voltage	TLC272C	V _O = 1.4V R _S = 50Ω	V _{IC} = 0, R _L = 10kΩ	25°C	0.12		10	mV
					Full range	12			
		TLC272AC	V _O = 1.4V, R _S = 50Ω	V _{IC} = 0, R _L = 10kΩ	25°C	0.12		5	
					Full range	6.5			
		TLC272BC	V _O = 1.4V, R _S = 50Ω	V _{IC} = 0, R _L = 10kΩ	25°C	0.12		2000	μV
					Full range	3000			
		TLC277C	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12		500	
					Full range	1500			
a _{VIO}	Temperature coefficient of input offset voltage			25°C to 70°C	0.3			μV/°C	
I _{IO}	Input offset current ⁽¹⁾	V _O = 2.5V	V _{IC} =2.5 V	25°C	10		60	pA	
				70°C	7		300		
I _{IB}	Input bias current ⁽¹⁾			25°C	10		60	pA	
				70°C	40		600		
V _{ICR}	Common-mode input voltage range ⁽²⁾			25°C	−0.1 to 4		−0.3 to 4.2	V	
				Full range	−0.1 to 3.5		V		
V _{OH}	High-level output voltage	V _{ID} = 100mV	R _L = 10kΩ	25°C	3.2		4.95	V	
				0°C	3		4.95		
				70°C	3		4.95		
V _{OL}	Low-level output voltage	V _{ID} = −100 mV	I _{OL} = 0	25°C	0		50	mV	
				0°C	0		50		
				70°C	0		50		
A _{VD}	Large-signal differential voltage amplification	V _O = 0.25V to 2V	R _L = 10kΩ	25°C	5		1000	V/mV	
				0°C	4				
				70°C	4				
CMRR	Common-mode rejection ratio	V _{IC} = −0.1V < V _{IC} < 3V		25°C	65		80	dB	
				0°C	60				
				70°C	60				
k _{SVR}	Supply-voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 5V to 10V	V _O =1.4 V	25°C	65		120	dB	
				0°C	60				
				70°C	60				
I _{DD}	Supply current (two amplifiers)	V _O = 2.5V, No load	V _{IC} = 2.5V,	25°C	1.12		3.2	mA	
				0°C			3.6		
				70°C			2.6		

(1) The typical values of input bias current and input offset current below 5pA were determined mathematically.

(2) This range also applies to each input individually.

4.4 Electrical Characteristics

at specified free-air temperature, $V_{DD} = 10V$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS		T _A	TLC272C, TLC272AC, TLC272BC, TLC277C			UNIT
						MIN	TYP	MAX	
V _{IO}	Input offset voltage	TLC272C	V _O = 1.4V R _S = 50Ω,	V _{IC} = 0, R _L = 10kΩ	25°C	0.12	10	mV	
					Full range		12		
		TLC272AC	V _O = 1.4V R _S = 50Ω	V _{IC} = 0, R _L = 10kΩ	25°C	0.12	5		
					Full range		6.5		
		TLC272BC	V _O = 1.4V, R _S = 50Ω	V _{IC} = 0, R _L = 10kΩ	25°C	0.12	2000	μV	
					Full range		3000		
		TLC277C	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12	800		
					Full range		1900		
a _{VIO}	Temperature coefficient of input offset voltage			25°C to 70°C	0.3		μV/°C		
I _{IO}	Input offset current ⁽¹⁾	V _O = 5V	V _{IC} = 5V	25°C	10	60	pA		
I _{IB}	Input bias current ⁽¹⁾			70°C	7	300			
				25°C	10	60	pA		
				70°C	50	600			
V _{ICR}	Common-mode input voltage range ⁽²⁾			25°C	-0.1 to 9	-0.3 to 9.2	V		
				Full range	-0.1 to 8.5		V		
V _{OH}	High-level output voltage	V _{ID} = 100mV	R _L = 10kΩ	25°C	8	9.95	V		
				0°C	7.8				
				70°C	7.8				
V _{OL}	Low-level output voltage	V _{ID} = -100 mV	I _{OL} = 0	25°C	0	50	mV		
				0°C	0	50			
				70°C	0	50			
A _{VD}	Large-signal differential voltage amplification	V _O = 1V to 6V	R _L = 10kΩ	25°C	10	1000	V/mV		
				0°C	7.5				
				70°C	7.5				
CMRR	Common-mode rejection ratio	V _{IC} = -0.1V < V _{IC} < 8V		25°C	65	85	dB		
				0°C	60				
				70°C	60				
k _{SVR}	Supply-voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 5V to 10V	V _O = 1.4V	25°C	65	120	dB		
				0°C	60				
				70°C	60				
I _{DD}	Supply current (two amplifiers)	V _O = 5V, No load	V _{IC} = 5V	25°C	1.12	4	mA		
				0°C		4.4			
				70°C		3.4			

(1) The typical values of input bias current and input offset current below 5pA were determined mathematically.

(2) This range also applies to each input individually.

4.5 Electrical Characteristics

at specified free-air temperature, $V_{DD} = 5V$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS		T _A	TLC272I, TLC272AI, TLC272BI, TLC277I			UNIT
						MIN	TYP	MAX	
V _{IO}	Input offset voltage	TLC272I	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12 10		mV	
					Full range	13			
		TLC272AI	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12 5			
					Full range	7			
		TLC272BI	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12 2000		μV	
					Full range	3500			
		TLC277I	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12 500			
					Full range	2000			
a _{VIO}	Temperature coefficient of input offset voltage				25°C to 85°C	0.3		μV/°C	
I _{IO}	Input offset current ⁽¹⁾	V _O = 2.5V,	V _{IC} = 2.5V	25°C	10	60	pA		
				85°C	24	15			
I _{IB}	Input bias current ⁽¹⁾			25°C	10	60	pA		
				85°C	200	35			
V _{ICR}	Common-mode input voltage range ⁽²⁾				25°C	-0.1 to 4	-0.3 to 4.2	V	
					Full range	-0.1 to 3.5		V	
V _{OH}	High-level output voltage	V _{ID} = 100mV	R _L = 10kΩ	25°C	3.2	4.95	V		
				-40°C	3	4.95			
				85°C	3	4.95			
V _{OL}	Low-level output voltage	V _{ID} = -100 mV	I _{OL} = 0	25°C	0	50	mV		
				-40°C	0	50			
				85°C	0	50			
A _{VD}	Large-signal differential voltage amplification	V _O = 1V to 6V	R _L = 10kΩ	25°C	5	1000	V/mV		
				-40°C	3.5				
				85°C	3.5				
CMRR	Common-mode rejection ratio	V _{IC} = -0.1 V < V _{IC} < 3V			25°C	65	80	dB	
					-40°C	60			
					85°C	60			
k _{SVR}	Supply-voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 5V to 10V	V _O = 1.4V	25°C	65	120	dB		
				-40°C	60				
				85°C	60				
I _{DD}	Supply current (two amplifiers)	V _O = 2.5V, No load	V _{IC} = 2.5V	25°C	1.12	3.2	mA		
				-40°C		4.4			
				85°C		2.4			

(1) The typical values of input bias current and input offset current below 5pA were determined mathematically.

(2) This range also applies to each input individually.

4.6 Electrical Characteristics

at specified free-air temperature, $V_{DD} = 10V$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS		T _A	TLC272I, TLC272AI, TLC272BI, TLC277I			UNIT
						MIN	TYP	MAX	
V _{IO}	Input offset voltage	TLC272I	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12		10	mV
					Full range	13			
		TLC272AI	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12		5	
					Full range	7			
		TLC272BI	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12		2000	μV
					Full range	3500			
		TLC277I	V _O = 1.4V R _S = 50Ω	V _{IC} = 0 R _L = 10kΩ	25°C	0.12		800	
					Full range	2900			
a _{VIO}	Temperature coefficient of input offset voltage				25°C to 85°C	0.3		μV/°C	
I _{IO}	Input offset current ⁽¹⁾	V _O = 5V	V _{IC} = 5V	25°C	10		60	pA	
I _{IB}	Input bias current ⁽¹⁾			85°C	26		1000		
				25°C	10		60	pA	
				85°C	220		2000		
V _{ICR}	Common-mode input voltage range ⁽²⁾				25°C	-0.1 to 9	-0.3 to 9.2	V	
					Full range	-0.1 to 8.5		V	
V _{OH}	High-level output voltage	V _{ID} = 100mV	R _L = 10kΩ	25°C	8		9.95	V	
				-40°C	7.8				
				85°C	7.8				
V _{OL}	Low-level output voltage	V _{ID} = -100 mV,	I _{OL} = 0	25°C	0		50	mV	
				-40°C	0		50		
				85°C	0		50		
A _{VD}	Large-signal differential voltage amplification	V _O = 1V to 6V	R _L = 10kΩ	25°C	10		1000	V/mV	
				-40°C	7				
				85°C	7				
CMRR	Common-mode rejection ratio	V _{IC} = -0.1V < V _{IC} < 8V			25°C	65		85	dB
					-40°C	60			
					85°C	60		88	
k _{SVR}	Supply-voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 5V to 10V	V _O = 1.4V	25°C	65		120	dB	
				-40°C	60				
				85°C	60				
I _{DD}	Supply current (two amplifiers)	V _O = 5V, No load	V _{IC} = 5V,	25°C	1.12		4	mA	
				-40°C			5		
				85°C			3.2		

(1) The typical values of input bias current and input offset current below 5pA were determined mathematically.

(2) This range also applies to each input individually.

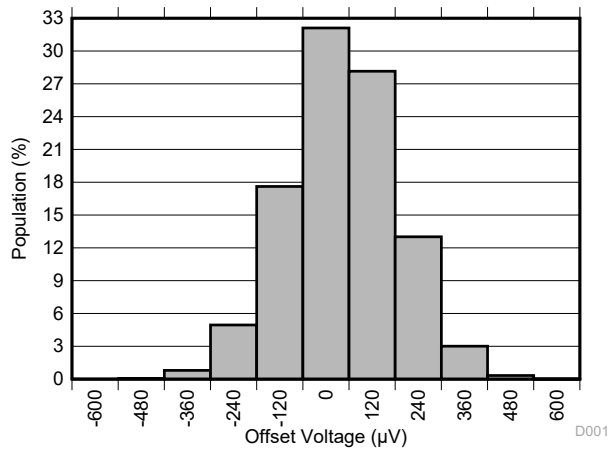
4.7 Operating Characteristics

at specified free-air temperature, $V_{DD} = 5V$

PARAMETER		TEST CONDITIONS		T_A	TLC272I, TLC272AI, TLC272BI, TLC277I TLC272C, TLC272AC, TLC272BC, TLC277C	UNIT
					MIN TYP MAX	
SR	Slew rate at unity gain	$R_L = 10k\Omega$ $C_L = 20pF$	$V_{Ipp} = 100mV$	25°C	0.5	V/ μs
			$V_{Ipp} = 1V$	25°C	21	
V_n	Equivalent input noise voltage	$f = 1kHz$	$R_S = 20\Omega$	25°C	10.8	nV/ \sqrt{Hz}
B_{OM}	Maximum output-swing bandwidth	$V_O = V_{OH}$ $R_L = 10k\Omega$	$C_L = 20pF$	25°C	10	kHz
B_1	Unity-gain bandwidth	$V_I = 10mV$	$C_L = 20pF$	25°C	4.5	MHz
ϕ_m	Phase margin	$V_I = 10mV$, $C_L = 20pF$	$f = B_1$	25°C	60°	

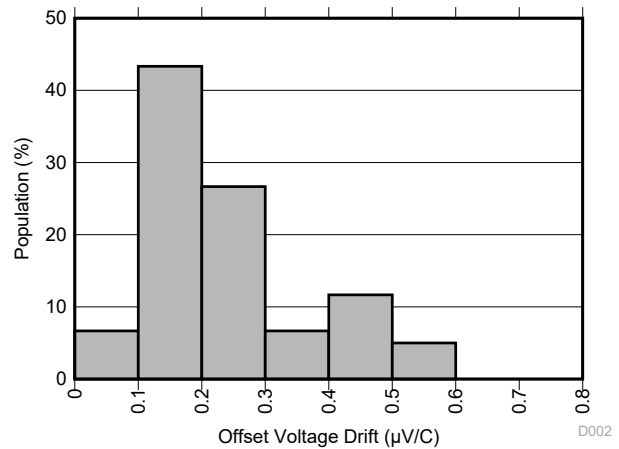
4.8 Typical Characteristics

at $T_A = 25^\circ\text{C}$, $V_S = \pm 20\text{V}$, $V_{CM} = V_S / 2$, $R_{LOAD} = 10\text{k}\Omega$ connected to $V_S / 2$, and $C_L = 10\text{pF}$ (unless otherwise noted)



Distribution from 15462 amplifiers, $T_A = 25^\circ\text{C}$

Figure 4-1. Offset Voltage Production Distribution



Distribution from 60 amplifiers

Figure 4-2. Offset Voltage Drift Distribution

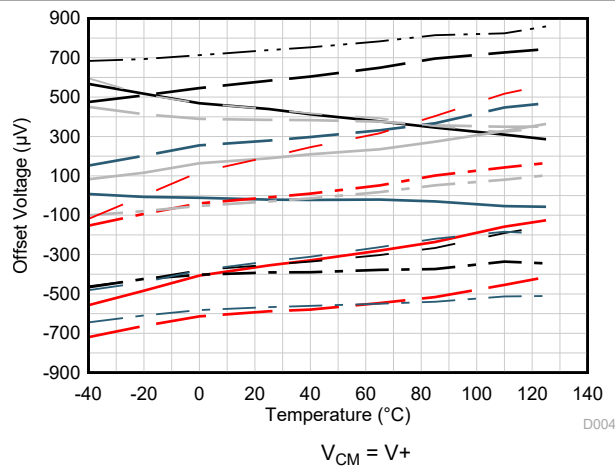


Figure 4-3. Offset Voltage vs Temperature

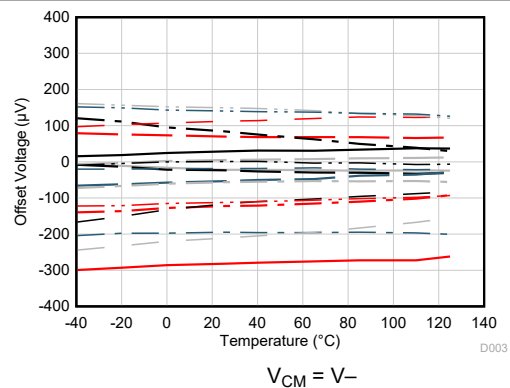


Figure 4-4. Offset Voltage vs Temperature

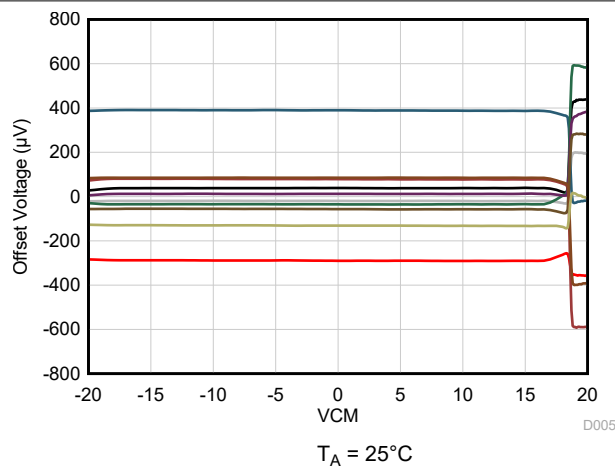


Figure 4-5. Offset Voltage vs Common-Mode Voltage

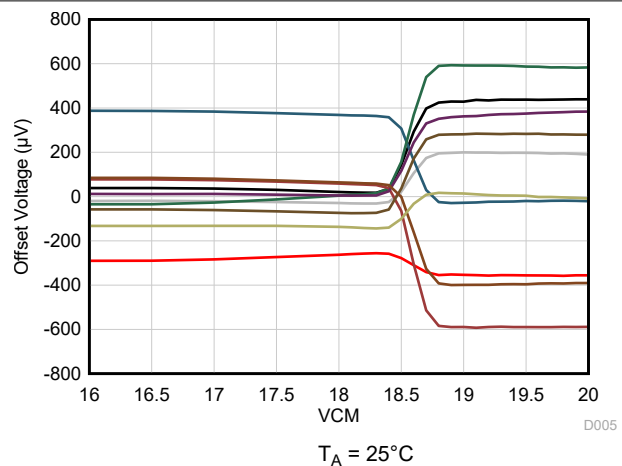


Figure 4-6. Offset Voltage vs Common-Mode Voltage (Transition Region)

4.8 Typical Characteristics (continued)

at $T_A = 25^\circ\text{C}$, $V_S = \pm 20\text{V}$, $V_{CM} = V_S / 2$, $R_{LOAD} = 10\text{k}\Omega$ connected to $V_S / 2$, and $C_L = 10\text{pF}$ (unless otherwise noted)

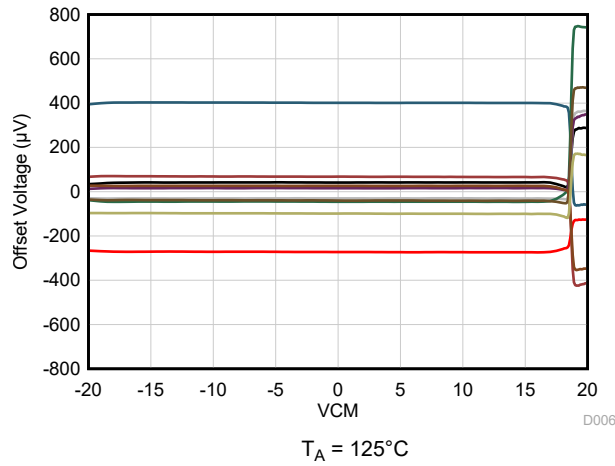


Figure 4-7. Offset Voltage vs Common-Mode Voltage

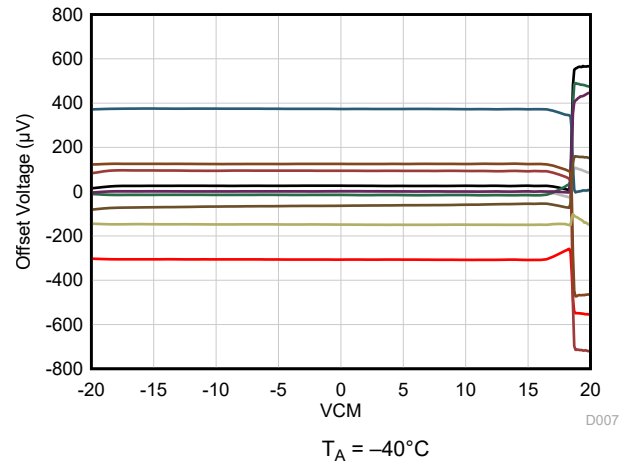


Figure 4-8. Offset Voltage vs Common-Mode Voltage

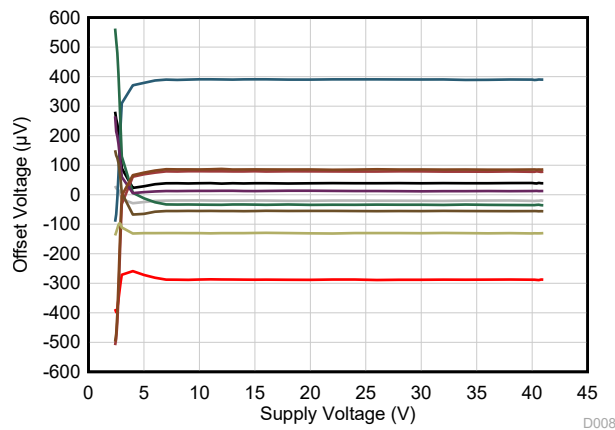


Figure 4-9. Offset Voltage vs Power Supply

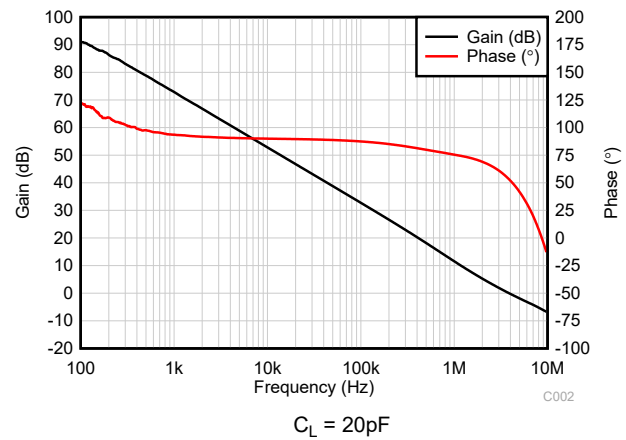


Figure 4-10. Open-Loop Gain and Phase vs Frequency

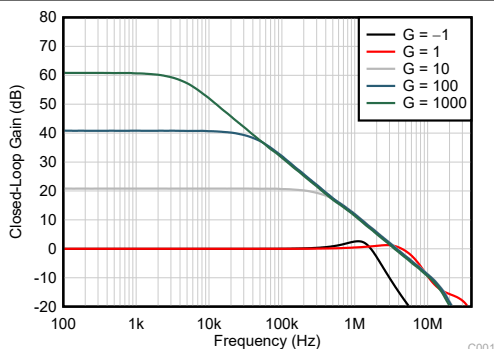


Figure 4-11. Closed-Loop Gain vs Frequency

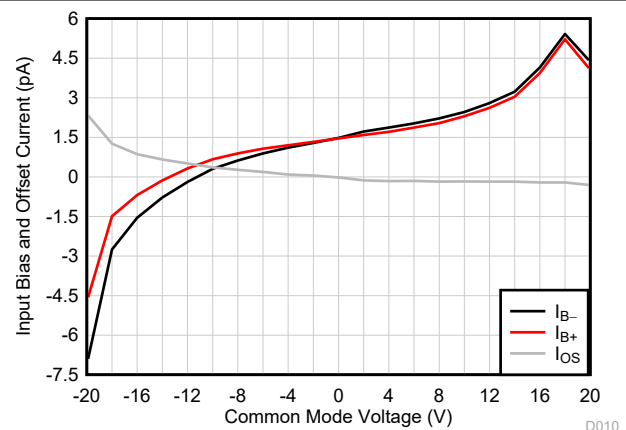


Figure 4-12. Input Bias Current vs Common-Mode Voltage

4.8 Typical Characteristics (continued)

at $T_A = 25^\circ\text{C}$, $V_S = \pm 20\text{V}$, $V_{CM} = V_S / 2$, $R_{LOAD} = 10\text{k}\Omega$ connected to $V_S / 2$, and $C_L = 10\text{pF}$ (unless otherwise noted)

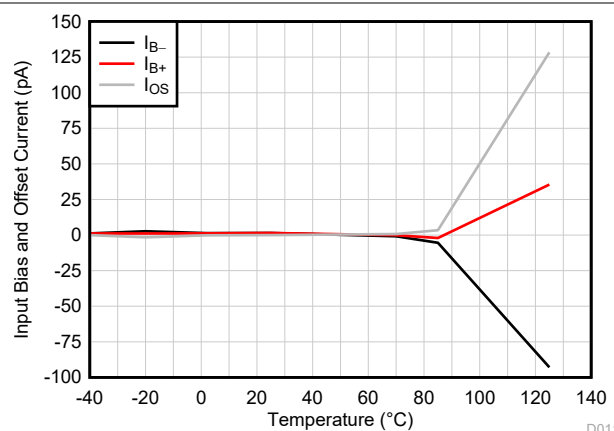


Figure 4-13. Input Bias Current vs Temperature

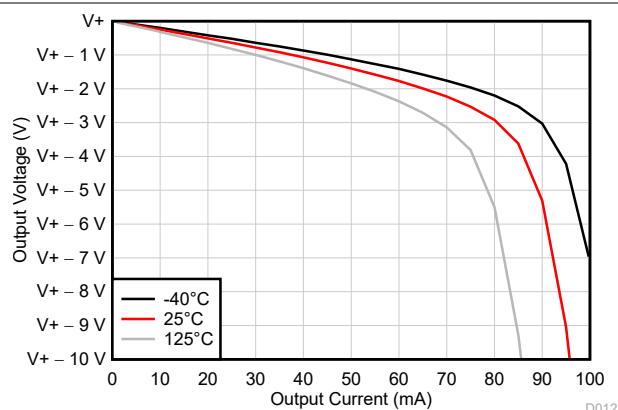


Figure 4-14. Output Voltage Swing vs Output Current (Sourcing)

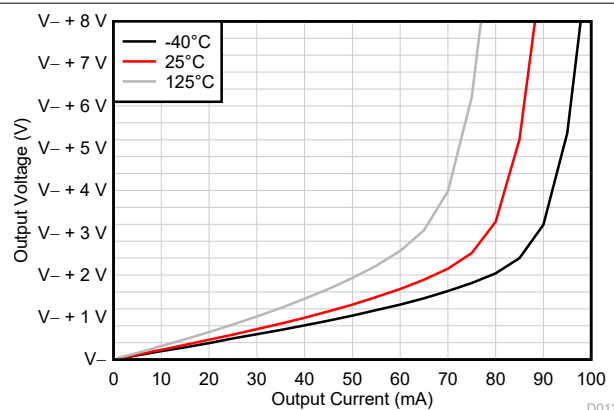


Figure 4-15. Output Voltage Swing vs Output Current (Sinking)

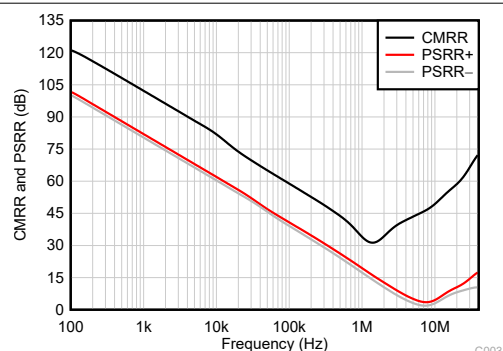


Figure 4-16. CMRR and PSRR vs Frequency

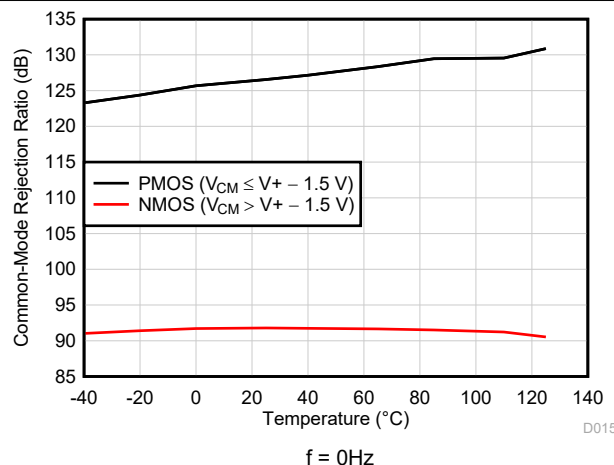


Figure 4-17. CMRR vs Temperature (dB)

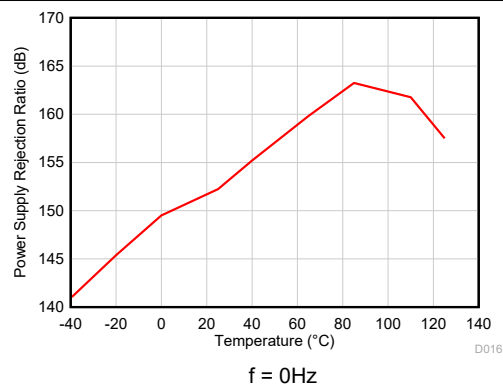


Figure 4-18. PSRR vs Temperature (dB)

5 Parameter Measurement Information

5.1 Single-Supply vs Split-Supply Test Circuits

Because the TLC272 and TLC277 are optimized for single-supply operation, circuit configurations used for the various tests often present some inconvenience since the input signal, in many cases, must be offset from ground. This inconvenience can be avoided by testing the device with split supplies and the output load tied to the negative rail. A comparison of single-supply versus split-supply test circuits is shown below. The use of either circuit gives the same result.

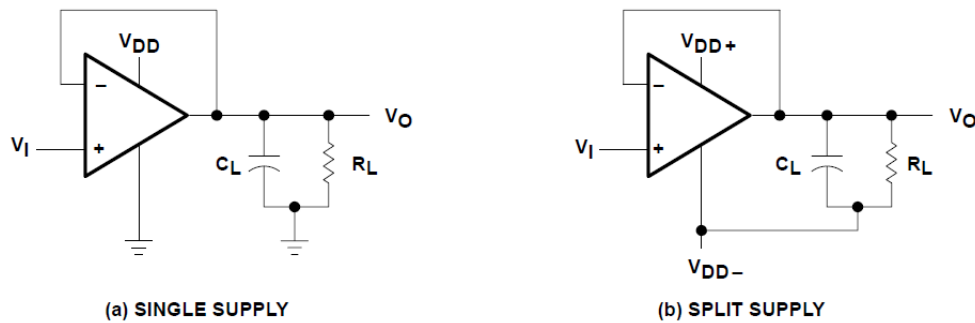


Figure 5-1. Unity-Gain Amplifier

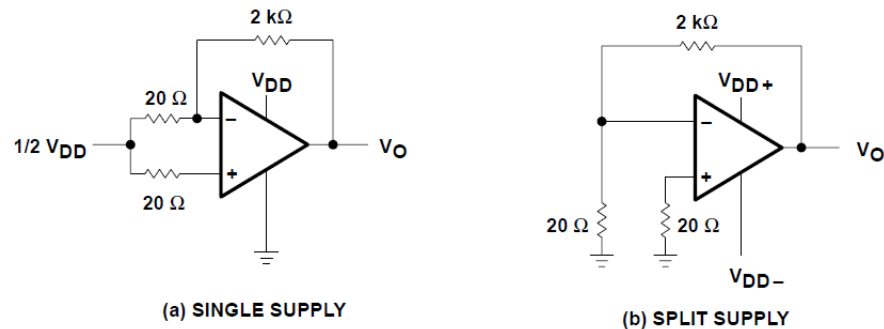


Figure 5-2. Noise-Test Circuit

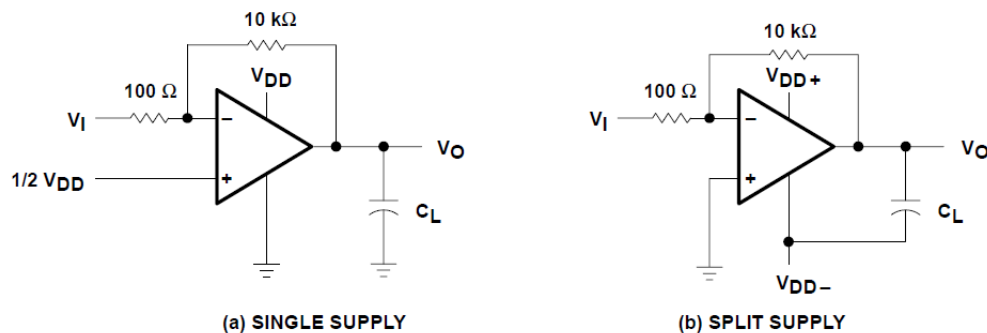


Figure 5-3. Gain-of-100 Inverting Amplifier

5.2 Input Bias Current

Because of the high input impedance of the TLC272 and TLC277 operational amplifiers, attempts to measure the input bias current can result in erroneous readings. The bias current at normal room ambient temperature is typically less than 1pA, a value that is easily exceeded by leakages on the test socket. Two suggestions are offered to avoid erroneous measurements:

1. Isolate the device from other potential leakage sources. Use a grounded shield around and between the device inputs (see [Figure 5-4](#)). Leakages that otherwise flow to the inputs are shunted away.
2. Compensate for the leakage of the test socket by actually performing an input bias current test (using a picoammeter) with no device in the test socket. The actual input bias current can then be calculated by subtracting the open-socket leakage readings from the readings obtained with a device in the test socket.

One word of caution: many automatic testers as well as some bench-top operational amplifier testers use the servo-loop technique with a resistor in series with the device input to measure the input bias current (the voltage drop across the series resistor is measured and the bias current is calculated). This method requires that a device be inserted into the test socket to obtain a correct reading; therefore, an open-socket reading is not feasible using this method.

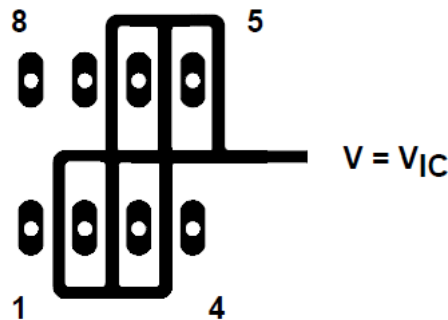


Figure 5-4. Isolation Metal Around Device Inputs (JG and P packages)

5.3 Low-Level Output Voltage

To obtain low-supply-voltage operation, some compromise is necessary in the input stage. This compromise results in the device low-level output being dependent on the common-mode input voltage level as well as the differential input voltage level. When attempting to correlate low-level output readings with those quoted in the electrical specifications, these two conditions must be observed.

5.4 Input Offset Voltage Temperature Coefficient

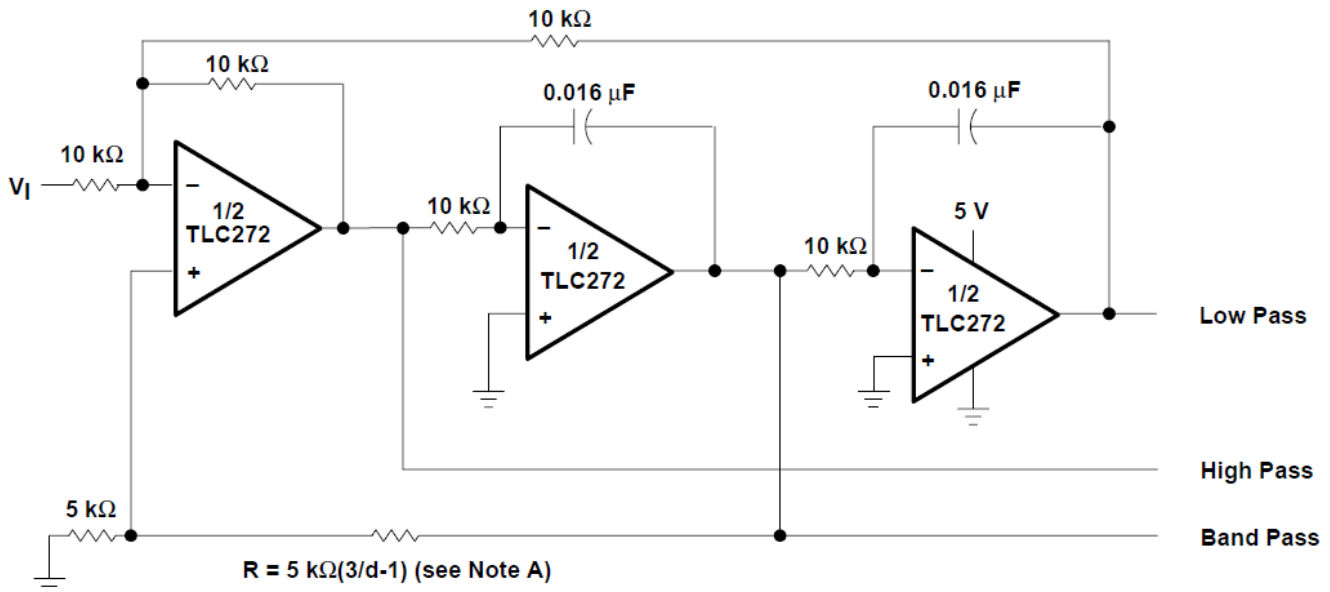
Erroneous readings often result from attempts to measure temperature coefficient of input offset voltage. This parameter is actually a calculation using input offset voltage measurements obtained at two different temperatures. When one (or both) of the temperatures is below freezing, moisture can collect on both the device and the test socket. This moisture results in leakage and contact resistance, which can cause erroneous input offset voltage readings. The isolation techniques previously mentioned have no effect on the leakage because the moisture also covers the isolation metal, thereby rendering the method useless. TI also suggests that these measurements be performed at temperatures above freezing to minimize error.

6 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

6.1 Application Information



A. d = damping factor, $1/Q$

Figure 6-1. State-Variable Filter

6.1.1 Single-Supply Operation

While the TLC272 and TLC277 perform well using dual power supplies (also called balanced or split supplies), the design is optimized for single-supply operation. This design includes an input common-mode voltage range that encompasses ground as well as an output voltage range that pulls down to ground. The supply voltage range extends down to 3V (C-suffix types), thus allowing operation with supply levels commonly available for TTL and HCMOS; however, for maximum dynamic range, 16V single-supply operation is recommended.

Many single-supply applications require that a voltage be applied to one input to establish a reference level that is above ground. A resistive voltage divider is usually sufficient to establish this reference level (see [Figure 6-2](#)). The low input bias current of the TLC272 and TLC277 permits the use of very large resistive values to implement the voltage divider, thus minimizing power consumption.

The TLC272 and TLC277 work well in conjunction with digital logic; however, when powering both linear devices and digital logic from the same power supply, the following precautions are recommended:

1. Power the linear devices from separate bypassed supply lines (see [Figure 6-3](#)); otherwise, the linear device supply rails can fluctuate due to voltage drops caused by high switching currents in the digital logic.
2. Use proper bypass techniques to reduce the probability of noise-induced errors. Single capacitive decoupling is often adequate; however, high-frequency applications can require RC decoupling.

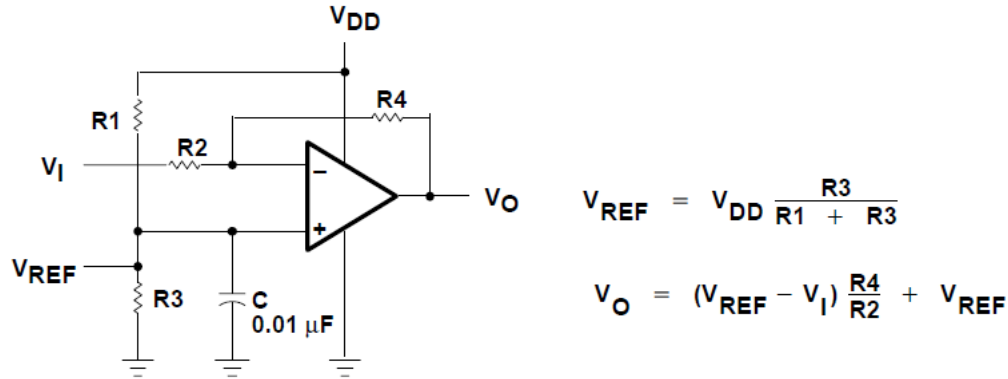


Figure 6-2. Inverting Amplifier With Voltage Reference

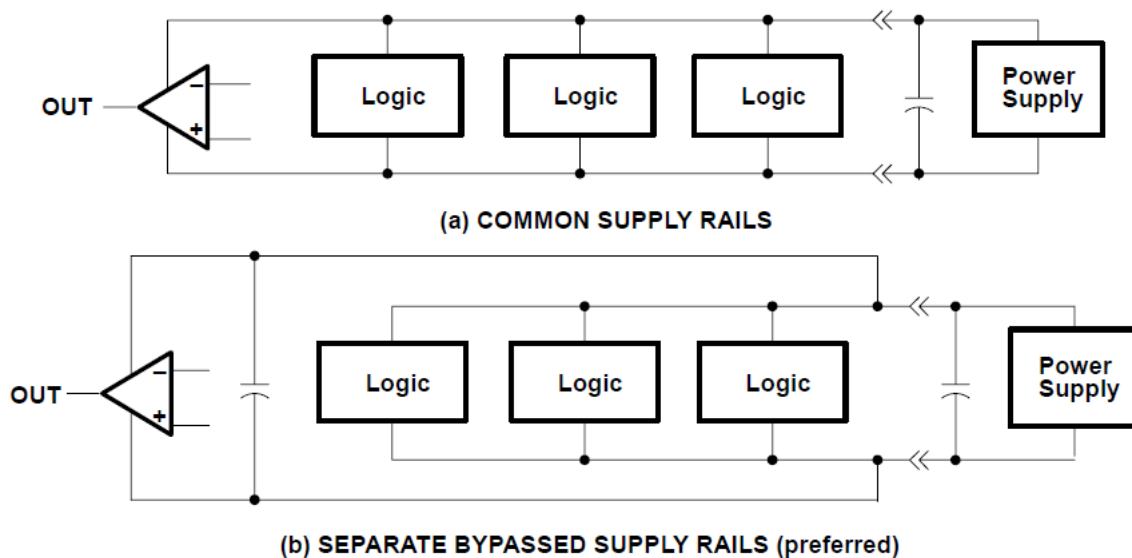


Figure 6-3. Common vs Separate Supply Rails

6.1.2 Input Characteristics

The TLC272 and TLC277 are specified with a minimum and a maximum input voltage that, if exceeded at either input, can cause the device to malfunction. Exceeding this specified range is a common problem, especially in single-supply operation. Note that the lower range limit includes the negative rail, while the upper range limit is specified at $V_{DD} - 1V$ at $T_A = 25^\circ C$ and at $V_{DD} - 1.5V$ at all other temperatures.

The use of the polysilicon-gate process and the careful input circuit design gives the TLC272 and TLC277 very good input offset voltage drift characteristics relative to conventional metal-gate processes. Offset voltage drift in CMOS devices is highly influenced by threshold voltage shifts caused by polarization of the phosphorus dopant implanted in the oxide. Placing the phosphorus dopant in a conductor (such as a polysilicon gate) alleviates the polarization problem, thus reducing threshold voltage shifts by more than an order of magnitude. The offset voltage drift with time has been calculated to be typically $0.1\mu V/\text{month}$, including the first month of operation.

Because of the extremely high input impedance and resulting low bias current requirements, the TLC272 and TLC277 are well suited for low-level signal processing; however, leakage currents on printed-circuit boards and sockets can easily exceed bias current requirements and cause a degradation in device performance. Including guard rings around inputs (similar to those of Figure 5-4 in the Section 5 section) is good practice. These guards must be driven from a low-impedance source at the same voltage level as the common-mode input (see Figure 6-4).

Connect unused amplifiers as grounded unity-gain followers to avoid possible oscillation.

6.1.3 Noise Performance

The noise specifications in operational amplifier circuits are greatly dependent on the current in the first-stage differential amplifier. The low input bias current requirements of the TLC272 and TLC277 result in a very low noise current, which is insignificant in most applications. This feature makes the devices especially favorable over bipolar devices when using values of circuit impedance greater than 50k Ω , since bipolar devices exhibit greater noise currents.

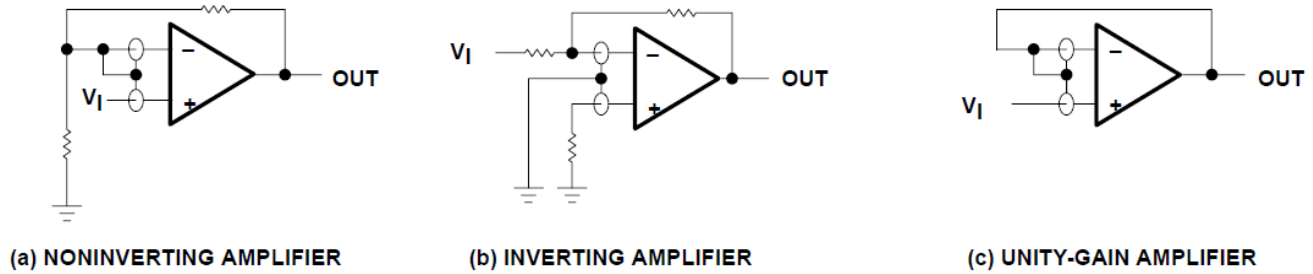


Figure 6-4. Guard-Ring Schemes

7 Device and Documentation Support

7.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

7.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

7.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

7.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

7.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

8 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision E (February 2002) to Revision F (January 2026)	Page
• Updated the numbering format for tables, figures, and cross-references throughout the document.....	1
• Deleted TLC272Y throughout the document.....	1
• Deleted input offset voltage drift bullet from the <i>Features</i>	1
• Deleted trimmed offset voltage bullet from the <i>Features</i>	1
• Changed low noise typical from 25nV/√Hz to 10.8nV/√Hz in the <i>Features</i>	1
• Deleted references to LinCMOS throughout the document.....	1
• Deleted the <i>Available Options</i> table in the <i>Description</i>	1
• Deleted Equivalent Schematic figure from the document.....	1
• Added the <i>Pin Configuration and Functions</i> section.....	3
• Deleted FK package pinout details from the document.....	3
• Deleted all tables in the <i>Specifications</i> related to TLC272M and TLC272Y.....	4
• Deleted M-suffix and FK package related information in the <i>Absolute Maximum Ratings</i> table.....	4
• Deleted the <i>Dissipation Ratings</i> table.....	4
• Deleted M suffix table column in the <i>Recommended Operating Conditions</i> table.....	4
• Changed Input offset Voltage for 272C typical from 1.1mV to 0.12mV in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Input offset Voltage for 272AC typical from 0.9mV to 0.12mV in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Input offset Voltage for 272BC typical from 230μV to 0.12mV in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Input offset Voltage for 277C typical from 200μV to 0.12mV in all of the <i>Electrical Characteristics</i> tables.....	5

• Changed Temperature coefficient of input offset voltage from 1.8μV/°C to 0.3μV/°C in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Input offset current from 0.1pA to 10pA in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Input bias current from 0.6pA to 10pA in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Common-mode input voltage range at 25°C and full range from –0.2V to –0.1V in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed High-level output voltage at 5V, 25°C, 0°C and 70°C from 3.8V to 4.95V in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed Large-signal differential voltage amplification at 25°C from 23V/mV to 1000V/mV in all of the <i>Electrical Characteristics</i> tables.....	5
• Deleted large-signal differential voltage amplification at 0°C and 70°C in all of the <i>Electrical Characteristics</i> tables.....	5
• Deleted common-mode rejection ratio at 0°C and 70°C in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed supply-voltage rejection ratio at 25°C from 95dB to 120dB in all of the <i>Electrical Characteristics</i> tables.....	5
• Deleted Supply-voltage rejection ratio at 0°C and 70°C in all of the <i>Electrical Characteristics</i> tables.....	5
• Deleted Supply current (two amplifiers) at 25°C from 1.4mA to 1.12mA in all of the <i>Electrical Characteristics</i> tables.....	5
• Deleted Supply current (two amplifiers) at 0°C and 70°C in all of the <i>Electrical Characteristics</i> tables.....	5
• Changed high-level output voltage at 10V, 25°C from 8.5V to 9.95V in the 10V <i>Electrical Characteristics</i> table.....	6
• Deleted high-level output voltage at 10V, 0°C and 70°C in the <i>Electrical Characteristics</i> table.....	6
• Changed Equivalent input noise voltage from 25nV/√Hz to 10.8nV/√Hz in the <i>Operating Characteristics</i> table.....	9
• Changed V _{IPP} from 1V to 100mV and 2.5V to 1V in the <i>Operating Characteristics</i> table.....	9
• Changed Maximum output-swing bandwidth from 320kHz to 10kHz in the <i>Operating Characteristics</i> table.....	9
• Changed Slew Rate at Unity gain typical at V _{IPP} 100mV from 3.6V/μs to 0.5V/μs and at 1V from 2.9V/μs to 21V/μs in the <i>Operating Characteristics</i> table.....	9
• Changed Unity gain bandwidth typical from 1.7MHz to 4.5MHz in the <i>Operating Characteristics</i> table.....	9
• Changed Phase Margin typical from 46° to 60° in the <i>Operating Characteristics</i> table.....	9
• Deleted all values for –40°C and 85°C in the <i>Operating Characteristics</i> table.....	9
• Added TLC272C, TLC272AC TLC272BC, TLC277C in the <i>Operating Characteristics</i> table.....	9
• Updated the <i>Typical Characteristics</i> as per latest data.....	10
• Deleted <i>Full Power Response</i> and <i>Test Time</i> sections.....	14
• Deleted <i>Output Characteristics</i> , <i>Feedback</i> , <i>Electrostatic Discharge</i> , and <i>Latch-up</i> sections.....	17

9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025